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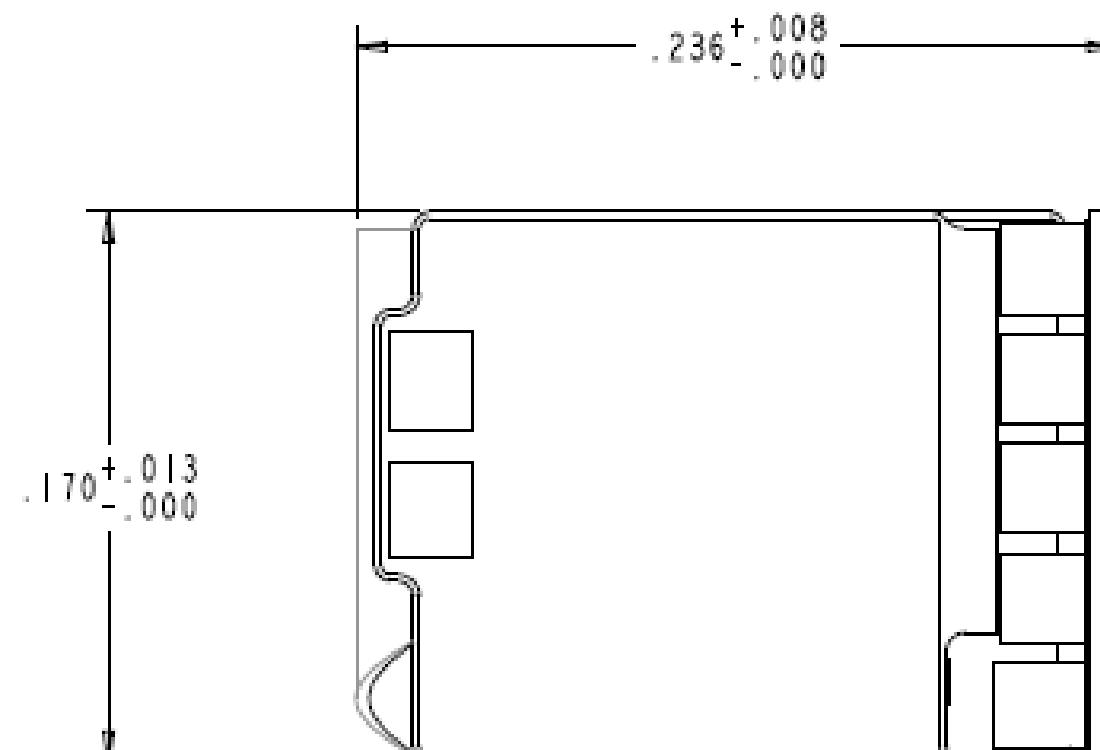
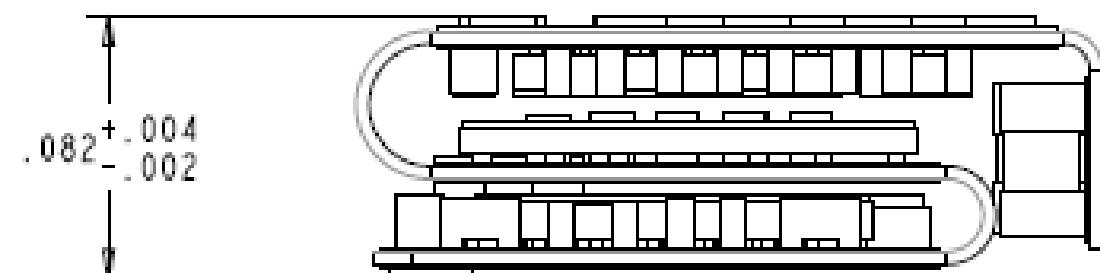
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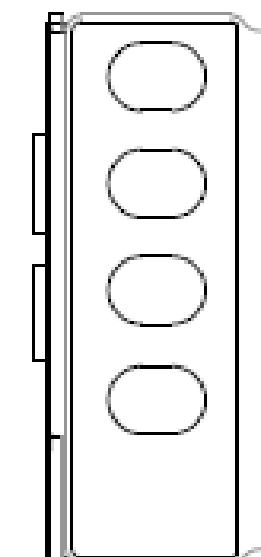
D

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.170
+.013
-.000



FOLDED ASSEMBLY NOTES:

1. FOLDED ASSEMBLY SHOWN WITH NOMINAL DIMENSIONS.

REVISIONS			
REV	ECO	CHANGE DESCRIPTION	DOC
D	MN51459	PCB changed to Rev B. Wider pads for Tanulum caps.C401 is masked over.	EG
C	MN49709	Add laser excise for China to cut out circuits from panel. Remove stencil opening from C401.	DSA

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FOLDED ASSEMBLY:

Sheet 1 Top, Bottom, Side Views with
Dimensions & Tolerances

FLAT ASSEMBLY:

Sheet 2 Assembly Top

Sheet 3 Flux Top

Sheet 4 Stencil Top

Sheet 5 Assembly Bottom

Sheet 6 Flux Bottom

Sheet 7 Stencil Bottom

LASER EXCISE SPECIFICATIONS:

Sheet 8 Excise Gerber

Sheet 9 Excise Quality and Packaging

MATERIAL:	TOLERANCE UNLESS OTHERWISE SPECIFIED INCHES [MM]			ANGLES 1°	TITLE: MSS HA ASSY DWG
	X.X +/- .020 [0.51]	X.XX +/- .010 [0.25]	X.XXX +/- .005 [0.13]		
	X.XXXX +/- .0010 [0.025]				
FINISH:	BY	SIGNATURE	DATE		
	DRFT	Thomas Bartosh	3-07-17		
	CHKD	Glenn Burnside	3-07-17		
	ENGR	Kristi Khondkar	3-14-17		
	QLTY	Greg Zhang	3-14-17		
SIZE:	PCB CODE:	PART NUMBER:			
B	MSS	53160D000	D		
SCALE:	NTS				
SHEET NO.:	1 OF 9				



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Eden Prairie, MN. 55344
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www.Starkey.com

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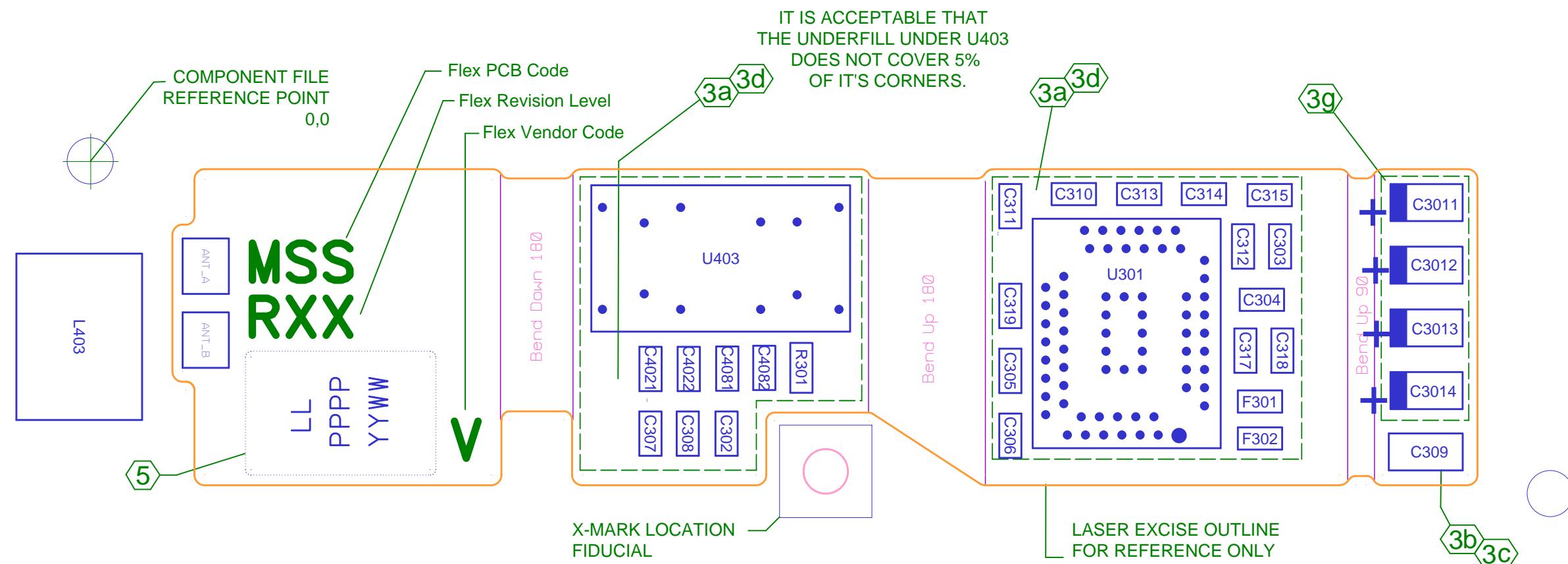
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FLAT SMD ASSEMBLY TOP VIEW



FLAT ASSEMBLY NOTES

- SEE 53114-940 FOR SCHEMATIC.
- INDIVIDUAL LAYERS AND GERBER FILES ARE DETAILED ON SUBSEQUENT PAGES. ACTUAL GERBER FILES ARE HELD IN DOCUMENTATION SERVICES. GERBER FILES ARE IN A ZIPPED FILE WITH THE SAME PART NUMBER AND REV AS THE DOCUMENT EXCEPT WITH THE "ZIP" EXTENSION.
- ③ UNDERFILL AND RESIDUE SHALL BE KEPT OFF THE TOP SURFACE OF ALL USER PADS AND TPs. NO UNDERFILL IS ALLOWED IN BEND AREAS BUT MAY BE WIPE OFF. OTHER AREAS WITH NO INDICATOR HAVE NO RESTRICTIONS. SEE 99008-169 FOR UNDERFILL INSPECTION CRITERIA. NOT ALL CONDITIONS APPLY TO THIS DRAWING.
 - ④ a. REINFORCE COMPONENTS WITH UNDERFILL.
 - ④ b. PARTIAL UNDERFILL IS ALLOWED BUT NOT REQUIRED.
 - ④ c. UNDERFILL IS ALLOWED ON TOP.
 - ④ d. WIPE EXCESS UNDERFILL FROM TOP.
 - ④ e. COVER EXPOSED PADS WITH UNDERFILL.
 - ④ f. DO NOT COVER EXPOSED PADS WITH UNDERFILL.
 - ④ g. UNDERFILL IS NOT ALLOWED.

4. DNP DETAILS:
 - a. 01 SIDE COMPONENTS: NONE
 - b. 04 SIDE COMPONENTS: C401
 - c. 01 SIDE FOOTPRINTS COVERED BY MASK: NONE
 - d. 04 SIDE FOOTPRINTS COVERED BY MASK: C401

5. LASER DATE CODE IN THIS AREA WITH THE FOLLOWING:
 - a. LL=LOCATION ON PANEL
 - b. PPPP = PANEL NUMBER
 - c. YY = LAST 2 DIGITS OF YEAR
 - d. WW = WEEK

SIZE:	PCB CODE:	PART NUMBER:	REV:
B	MSS	53160D000	D
SCALE: NTS			SHEET NO.: 2 OF 9

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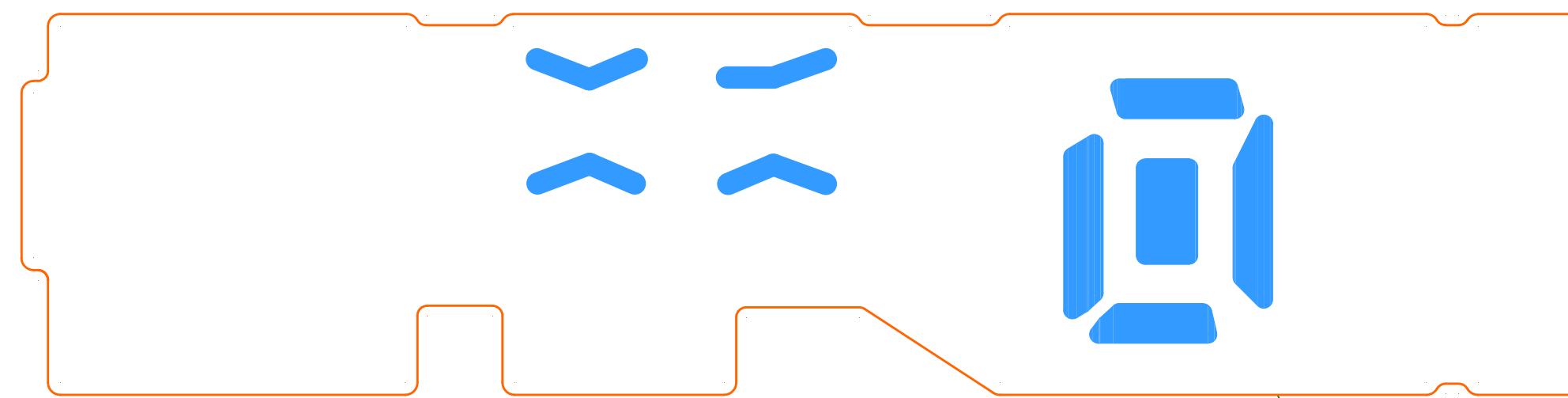
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TOP VIEW



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LASER EXCISE OUTLINE
FOR REFERENCE ONLY

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Gerber File Description

MSS-01-FLUX 03/12/15

SIZE:	PCB CODE:	PART NUMBER:	
B	MSS	53160D000	D
SCALE: NTS	SHEET NO.:	3 OF 9	

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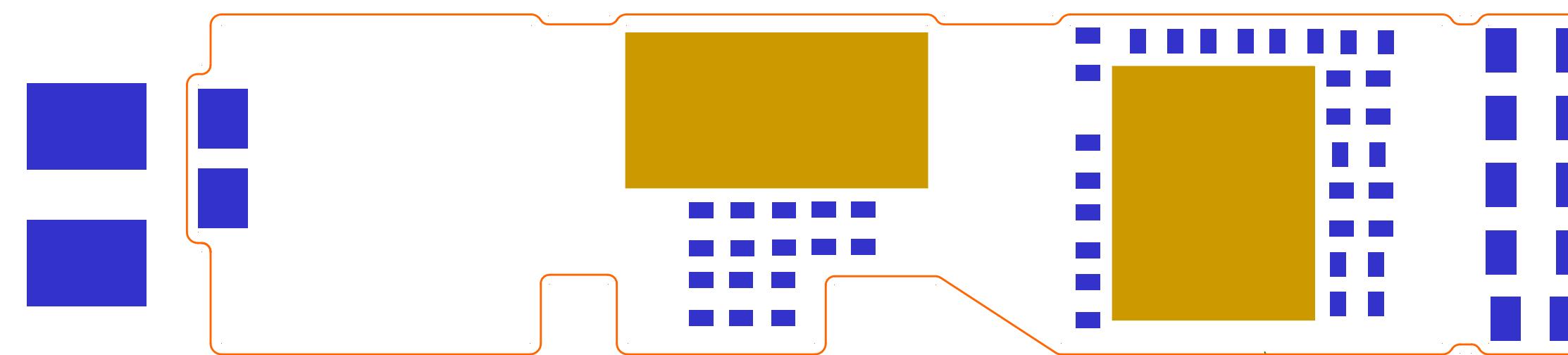
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TOP VIEW



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Gerber File Description

MSS-01-SOLDER-STENCIL 03/08/17

MSS-01-SOLDER-STENCIL-STEP 03/12/15

SIZE:	PCB CODE:	PART NUMBER:	REV:
B	MSS	53160D000	D
SCALE: NTS			SHEET NO.: 4 OF 9

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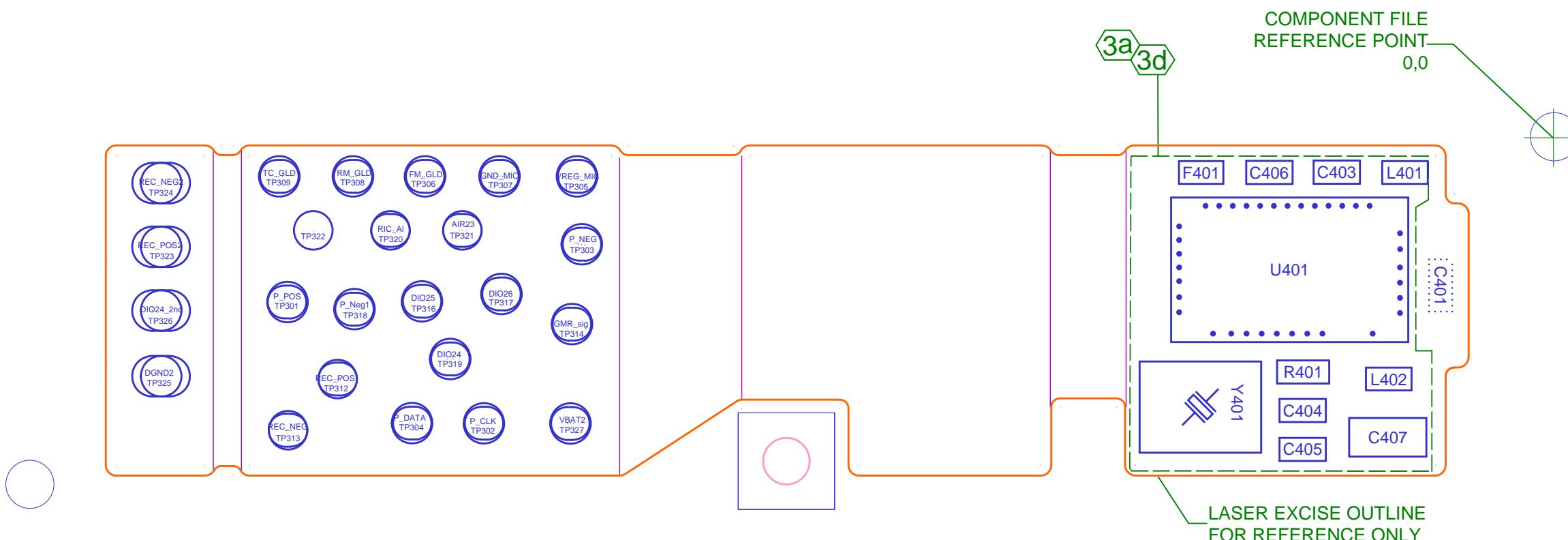
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FLAT SMD ASSEMBLY BOTTOM VIEW



SIZE:	PCB CODE:	PART NUMBER:	
B	MSS	53160D000	D
SCALE: NTS		SHEET NO.:	5 OF 9

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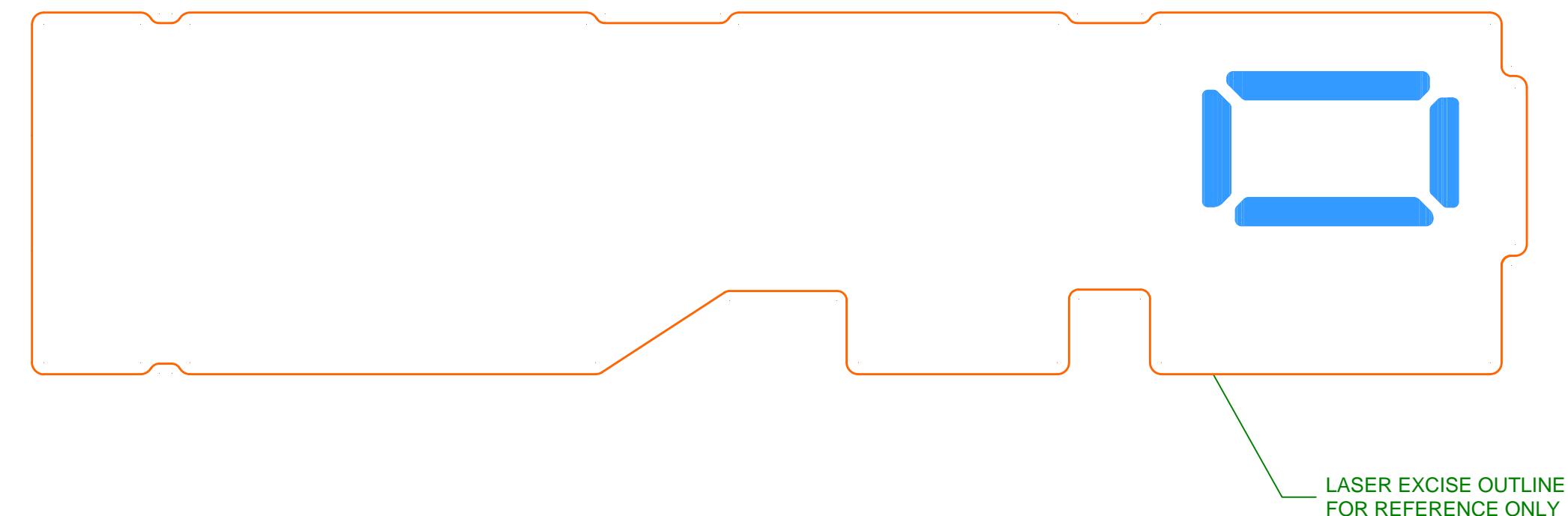
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BOTTOM VIEW



Gerber File Description

MSS-04-FLUX 03/12/15

SIZE:	PCB CODE:	PART NUMBER:	REV:
B	MSS	53160D000	D
SCALE: NTS			SHEET NO.: 6 OF 9

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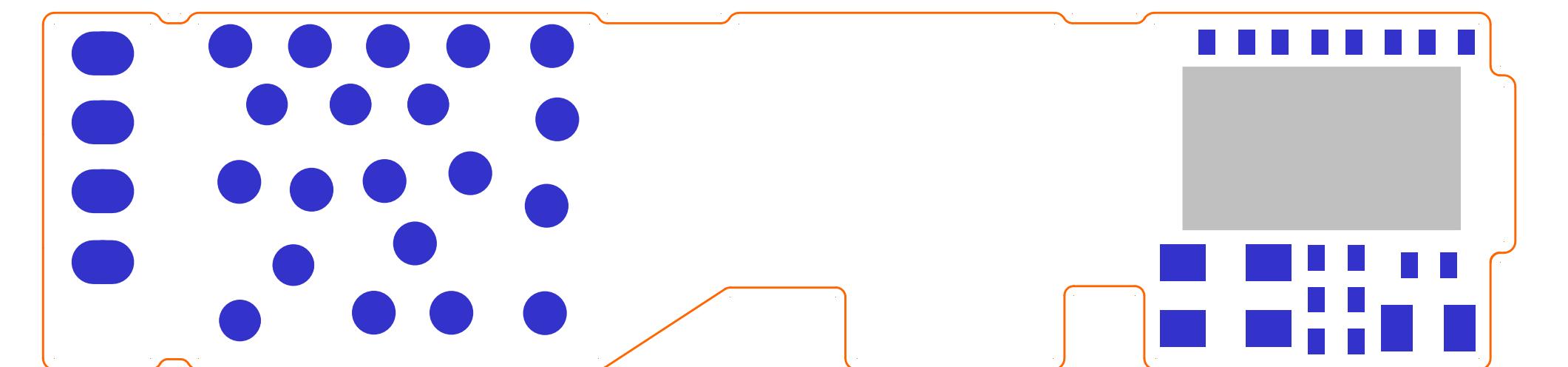
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BOTTOM VIEW



LASER EXCISE OUTLINE
FOR REFERENCE ONLY

Gerber File Description

MSS-04-SOLDER-STENCIL 03/08/17

MSS-04-SOLDER-STENCIL-STEP 03/12/15

SIZE:	PCB CODE:	PART NUMBER:	REV:
B	MSS	53160D000	D
SCALE: NTS			SHEET NO.: 7 OF 9

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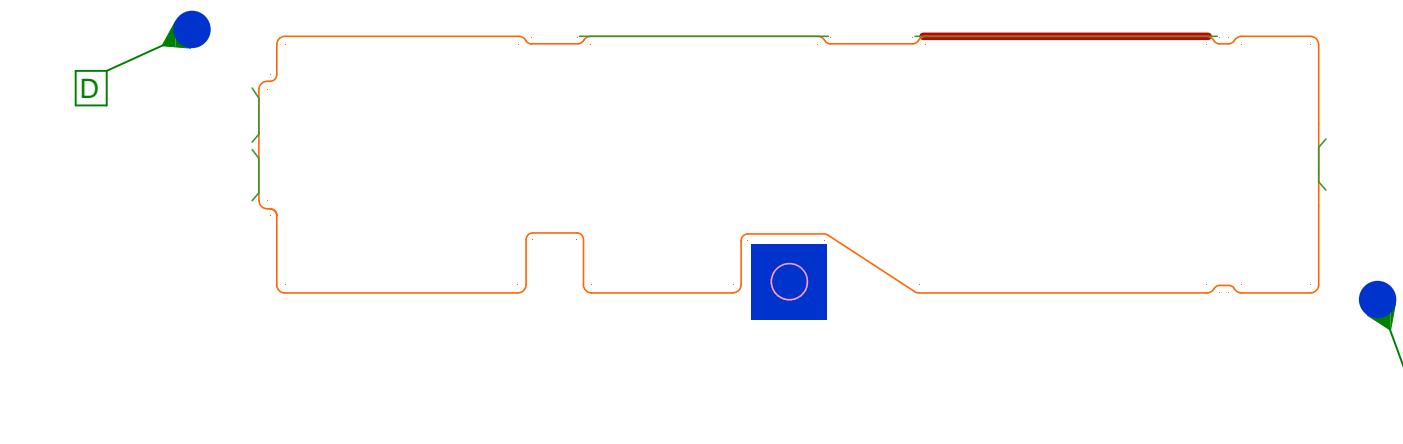
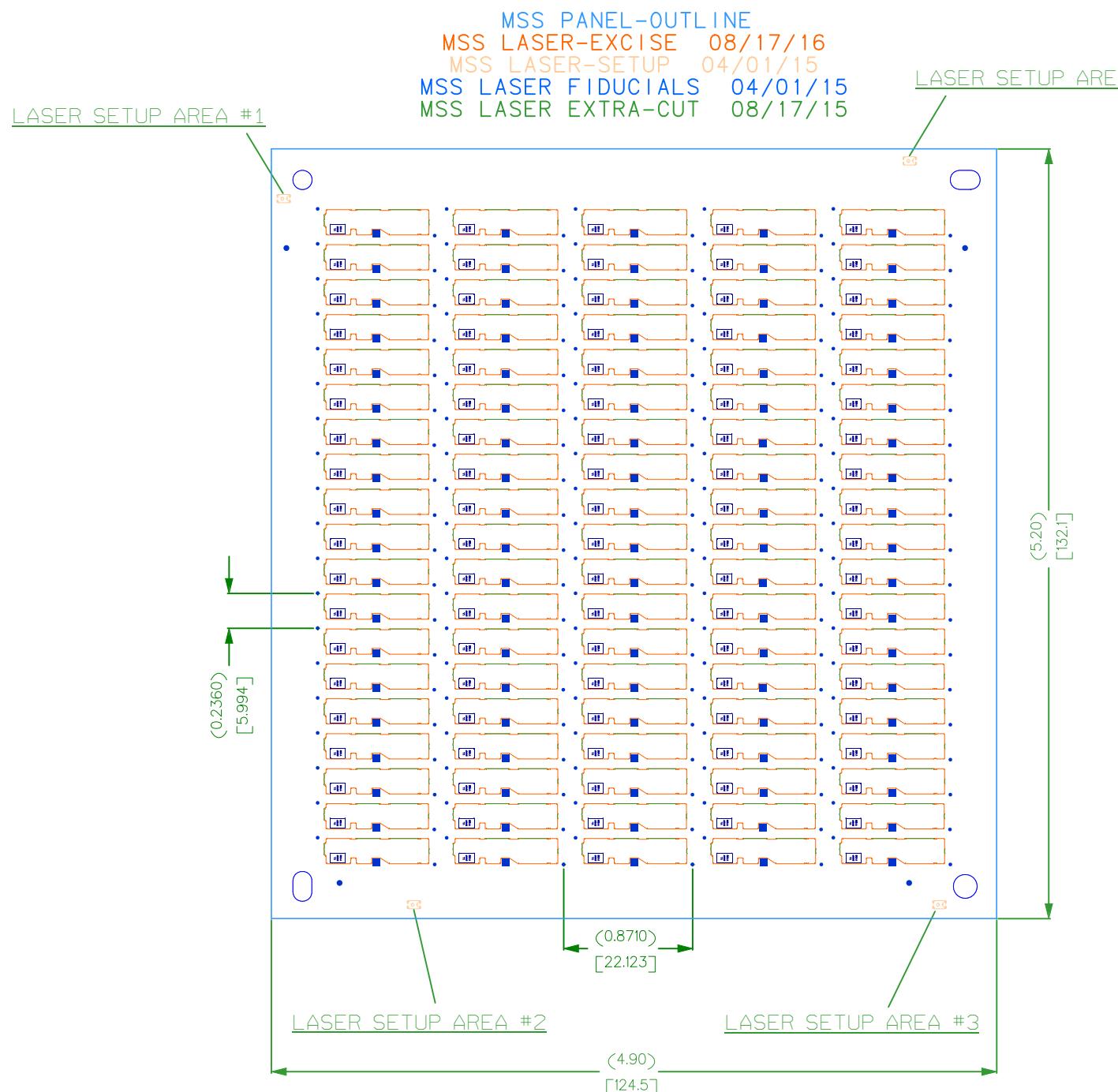
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TOP VIEWS - Excise Gerber



LASER EXCISE SPECIFICATIONS: Excise Gerber

1. INDIVIDUAL LAYERS AND GERBER FILES ARE DETAILED ON SUBSEQUENT PAGES. ACTUAL GERBER FILES ARE HELD IN DOCUMENTATION SERVICES. GERBER FILES ARE IN A ZIPPED FILE WITH THE SAME PART NUMBER AND REV AS THE DOCUMENT EXCEPT WITH THE "ZIP" EXTENSION.
2. ALL GERBER VIEWED FROM TOP LOOKING THROUGH BOARD FOR BOTTOM LAYERS
3. DATUM A IS THE PLANE DEFINED BY THE BOTTOM OF THE PANEL DATUMS D AND E ARE LOCAL FIDUCIALS THAT APPLY TO EACH AND EVERY CIRCUIT INDIVIDUALLY.
4. LASER ROUTED EDGE:
 - a. CRITICAL AREAS: .006 [.015] A | D | E
CRITICAL EDGES, IF PRESENT, WILL BE DISPLAYED BY A WIDER RED LINE.
 - b. NON-CRITICAL AREAS: .008 [.020] A | D | E
 - c. LASER EXCISE GERBER AND EXTRA CUT GERBER ARE COMPENSATED FOR 1-MIL KERF.

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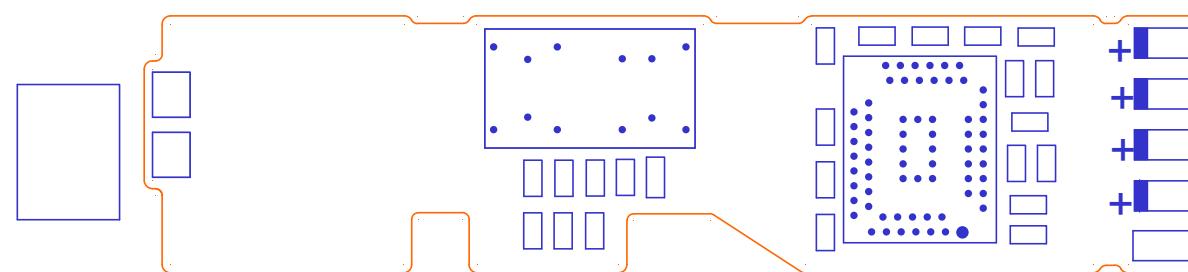
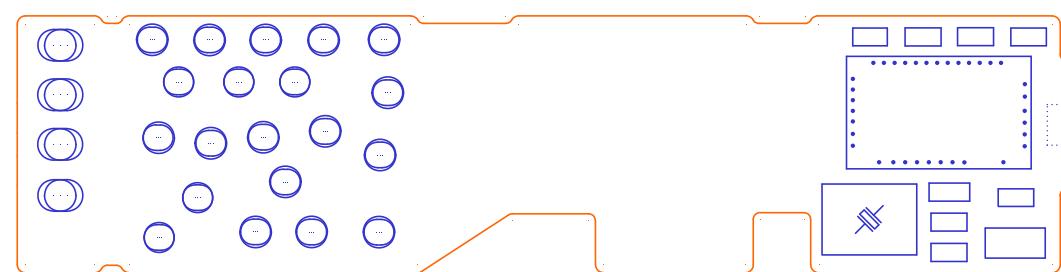
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**BOTTOM VIEW
LASER EXCISE SIDE****TOP VIEW**PARTS ARE SHOWN FOR REFERENCE ONLY**LASER EXCISE SPECIFICATIONS: Excise Quality and Packaging****5. QUALITY**

- a. LASER KERF EDGE SHALL BE SMOOTH.
- b. LASER MUST COMPLETELY CUT THROUGH PCB MATERIAL.
- c. EXCESSIVE LASER DEBRIS ALONG CUT LINE IS NOT ALLOWED.
LASER DEBRIS SHALL NOT INHIBIT THE SOLDERABILITY OF GOLD PLATED PADS.
- d. PARTS SHALL BE PROTECTED FROM DAMAGE DUE TO HANDLING,
ELECTROSTATIC DISCHARGE, OR EXCESSIVE HUMIDITY.
- e. NO CHEMICAL, AQUEOUS OR PLASMA CLEANING IS ALLOWED WITHOUT STARKEY APPROVAL.
- f. NO REWORK IS ALLOWED WITHOUT STARKEY APPROVAL.

6. PACKAGING.

- a. PARTS TO BE DELIVERED IN ARRAY
- b. PACKAGE TO SHIP AS RECEIVED: ON PALLET 53160-986, IN SAME CASSETTE, IN SAME BOX.
- c. THE ADDITION OF A DESICCANT SACHET AND A MOISTURE INDICATOR IS REQUIRED.

SIZE:	PCB CODE:	PART NUMBER:	REV:
B	MSS	53160D000	D
SCALE: NTS			SHEET NO.: 9 OF 9

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